# IBM HUDSON VALLEY RESEARCH PARK EAST FISHKILL HOPEWELL JUNCTION, NEW YORK

IBM Hudson Valley Research Park (East Fishkill) of Hopewell Junction, New York develops and manufactures semiconductor logic and memory device chips. The site also is home to the Interconnect Products packaging manufacturing operations, the Advanced Semiconductor Technology Center, and several non-IBM manufacturing and office companies. The facility is certified to ISO 14001. IBM HVRP is an EPA Project XL site that reuses

## ENVIRONMENTAL PERFORMANCE

## Past Accomplishments

F006 sludge.

IBM Hudson Valley Research Park has demonstrated its commitment to environmental performance in the areas of reduced emissions of toxics, and reduced hazardous waste. From 1997 to 1999, the facility:

AT A GLANCE	
Industry Sector:	SIC 3674

Business: Develops and manufactures

semiconductor chips. Manufactures product

packaging

Facility Employees: more than 1,000

Accomplishments: Reduced air toxics emssions

Reduced hazardous waste

2003 Commitments: Reduce hazardous waste

Reduce water use Reduce energy use Reduce use of hazardous

materials

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Hopewell Junction, NY

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- **Reduced emissions of air toxics** by 72% through replacing percholoroethylene in mask cleaning operations with an aqueous cleaner and installing better air emission abatement technology for packaging manufacturing.
- **Reduced hazardous solid waste** per unit of production by 23% in 1998 and 15% in 1999 through implementing a variety of waste minimization measures identified by employee teams.

## Future Commitments

IBM Hudson Valley Research Park has also committed to continued environmental improvement. By 2003, the facility will:

- **Reduce hazardous waste** per unit of production by 5% per year through continued implementation of waste minimization projects.
- **Reduce water use** per unit of production by 2% per year through continued implementation of water conservation programs.
- **Reduce energy use** by 4% per year through expanded use of high-efficiency lighting systems, HVAC equipment, motors, VFDs, etc.
- **Reduce hazardous material use** by developing and producing lead-free and reduced lead semiconductor chips.

# COMMUNITY OUTREACH

IBM Hudson Valley Research Park identifies community concerns through communications with local government officials and state regulators. The facility responds to inquiries on a case-by-case basis. The facility involves the community in a variety of ways, depending on the issue. For example, IBM formed a stakeholder group of local, regional, and national representatives to participate in developing its

Project XL on F006 sludge reuse. The facility will distribute its annual performance report through its website, www.ibm.com/ibm/environment.			